

## 40V N-Channel Enhancement Mode MOSFET

### Description

The CP40N04QR uses Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

### General Features

- ◆  $V_{DS} = 40V$ ,  $I_D = 40A$   
 $R_{DS(ON)} = 5.2m\Omega$  (typical) @  $V_{GS} = 10V$   
 $R_{DS(ON)} = 8m\Omega$  (typical) @  $V_{GS} = 4.5V$
- ◆ Excellent gate charge x  $R_{DS(ON)}$  product(FOM)
- ◆ Very low on-resistance  $R_{DS(ON)}$
- ◆ 150 °C operating temperature
- ◆ Pb-free lead plating
- ◆ 100% UIS tested

### Application

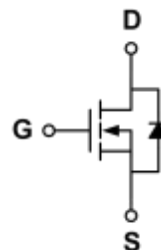
- ◆ DC/DC Converter
- ◆ Ideal for high-frequency switching and synchronous rectification

### Package

- ◆ DFN3X3-8L



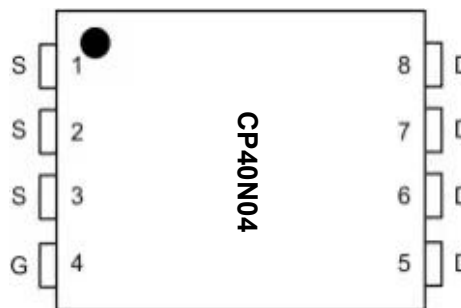
### Schematic diagram



### Marking and pin assignment

**DFN3×3-8L**

(Top View)



XXXX—Wafer Information

YYYY—Quality Code

### Ordering Information

| Part Number | Storage Temperature | Package   | Devices Per Reel |
|-------------|---------------------|-----------|------------------|
| CP40N04QR-G | -55°C to +150°C     | DFN3X3-8L | 5000             |

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

| parameter                                       | symbol              | limit | unit |
|-------------------------------------------------|---------------------|-------|------|
| Drain-source voltage                            | $V_{DS}$            | 40    | V    |
| Gate-source voltage                             | $V_{GS}$            | ±20   | V    |
| Drain Current-Continuous (Silicon Limited)      | $I_D$               | 40    | A    |
| Drain Current-Continuous( $T_C = 100^\circ C$ ) | $I_D (100^\circ C)$ | 20    | A    |
| Pulsed Drain Current (Package Limited)          | $I_{DM}$            | 160   | A    |

|                                      |          |         |    |
|--------------------------------------|----------|---------|----|
| Single pulse avalanche energy        | $E_{AS}$ | 350     | mJ |
| Maximum power dissipation            | $P_D$    | 65      | W  |
| Operating junction Temperature range | $T_j$    | -55—150 | °C |

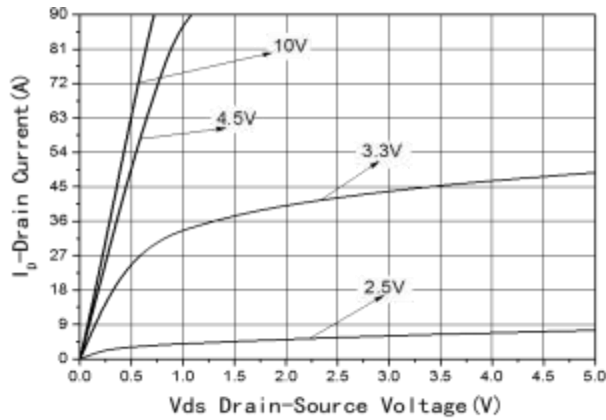
**Electrical Characteristics** ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

| Parameter                        | Symbol              | Condition                                                                                                                       | Min | Typ  | Max | Unit |
|----------------------------------|---------------------|---------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| OFF Characteristics              |                     |                                                                                                                                 |     |      |     |      |
| Drain-source breakdown voltage   | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                                                                      | 40  | -    | -   | V    |
| Zero gate voltage drain current  | I <sub>DSS</sub>    | V <sub>DS</sub> =40V, V <sub>GS</sub> =0V                                                                                       | -   | -    | 1   | μA   |
| Gate-body leakage                | I <sub>GSS</sub>    | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V                                                                                      | -   | -    | ±10 | μA   |
| ON Characteristics               |                     |                                                                                                                                 |     |      |     |      |
| Gate threshold voltage           | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                                                        | 1.0 | 1.5  | 2   | V    |
| Drain-source on-state resistance | R <sub>DS(ON)</sub> | V <sub>GS</sub> = 10V, I <sub>D</sub> =40A                                                                                      | -   | 5.2  | 11  | mΩ   |
|                                  |                     | V <sub>GS</sub> =4.5V, I <sub>D</sub> =40A                                                                                      | -   | 8    | 13  |      |
| Forward transconductance         | g <sub>fs</sub>     | V <sub>DS</sub> =5V, I <sub>D</sub> =40A                                                                                        | 26  | 30   | -   | S    |
| Dynamic Characteristics          |                     |                                                                                                                                 |     |      |     |      |
| Input capacitance                | C <sub>ISS</sub>    | V <sub>DS</sub> =-20V ,V <sub>GS</sub> =0V<br>f= 1.0MHz                                                                         | -   | 1991 | -   | pF   |
| Output capacitance               | C <sub>OSS</sub>    |                                                                                                                                 | -   | 180  | -   |      |
| Reverse transfer capacitance     | C <sub>RSS</sub>    |                                                                                                                                 | -   | 156  | -   |      |
| Switching Characteristics        |                     |                                                                                                                                 |     |      |     |      |
| Turn-on delay time               | t <sub>D(ON)</sub>  | V <sub>DS</sub> =-20V<br>I <sub>D</sub> =-2.8A<br>V <sub>GEN</sub> =-4.5V<br>R <sub>L</sub> = 10ohm<br>R <sub>GEN</sub> =-60ohm | -   | 14   | -   | ns   |
| Rise time                        | t <sub>r</sub>      |                                                                                                                                 | -   | 18   | -   |      |
| Turn-off delay time              | t <sub>D(OFF)</sub> |                                                                                                                                 | -   | 50   | -   |      |
| Fall time                        | t <sub>f</sub>      |                                                                                                                                 | -   | 21   | -   |      |
| Total gate charge                | Q <sub>g</sub>      | V <sub>DS</sub> =-20V,I <sub>D</sub> =-3A<br>V <sub>GS</sub> =-4.5V                                                             | -   | 33.4 | -   | nC   |
| Gate-source charge               | Q <sub>gs</sub>     |                                                                                                                                 | -   | 5.9  | -   |      |
| Gate-drain charge                | Q <sub>gd</sub>     |                                                                                                                                 | -   | 6.5  | -   |      |

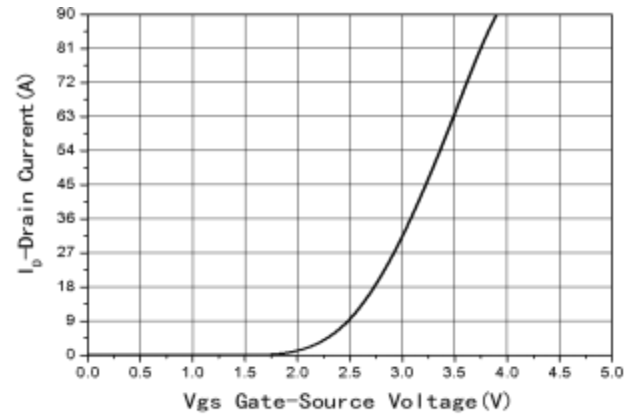
**Thermal Characteristics**

|                                        |             |     |      |
|----------------------------------------|-------------|-----|------|
| Thermal Resistance junction-to ambient | $R_{th JA}$ | 100 | °C/W |
|----------------------------------------|-------------|-----|------|

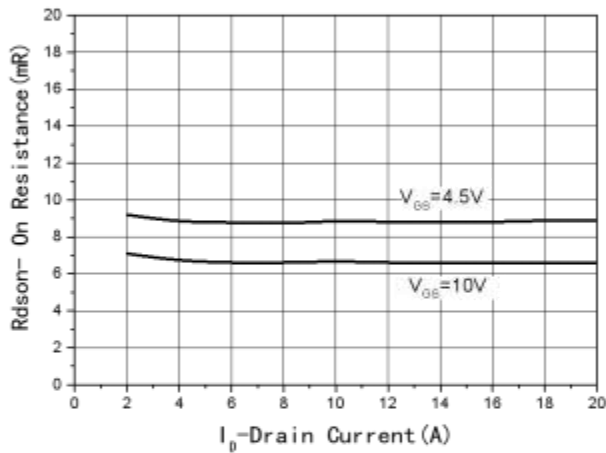
## Typical Performance Characteristics



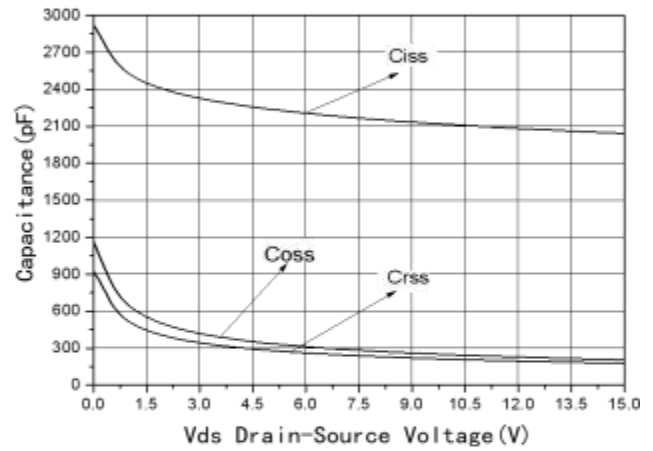
**Fig1 Output Characteristics**



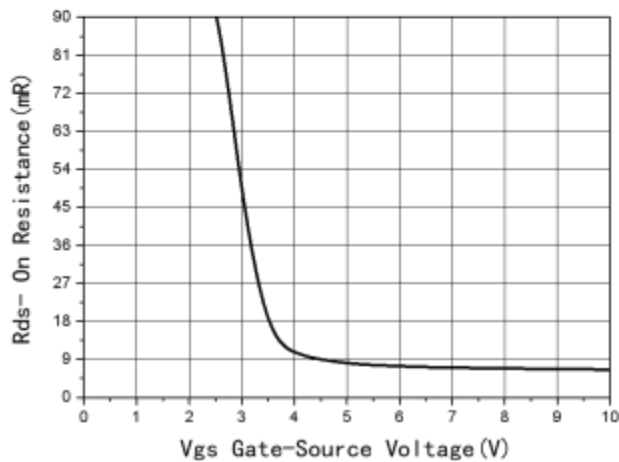
**Fig2 Transfer Characteristics**



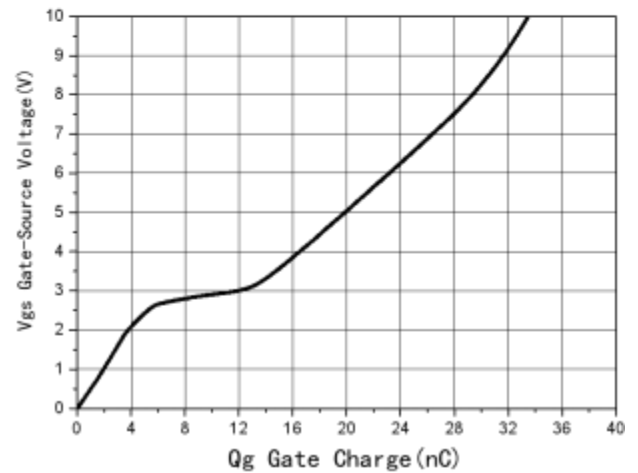
**Fig3  $R_{DS(on)}$ -Drain current**



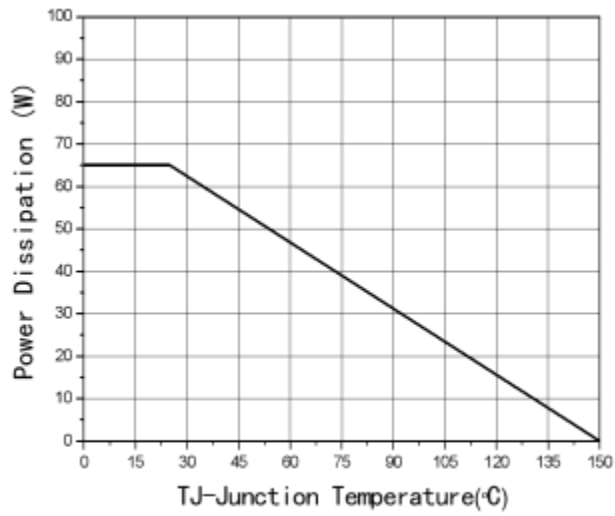
**Fig4 Capacitance vs  $V_{DS}$**



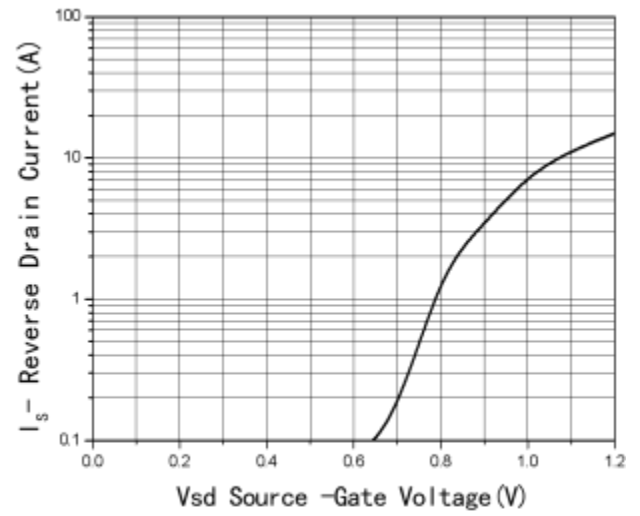
**Fig5  $R_{DS(on)}$ -Gate Drain voltage**



**Fig6 Gate Charge**



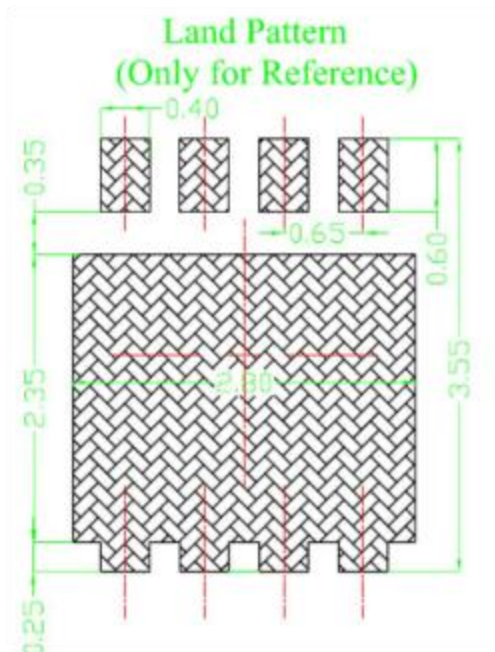
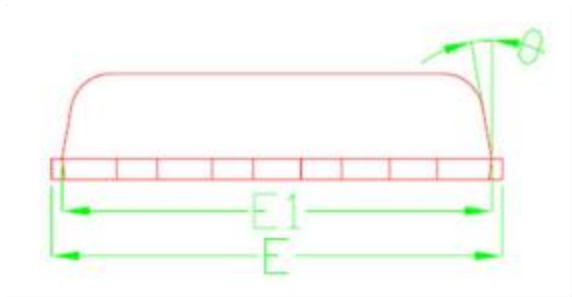
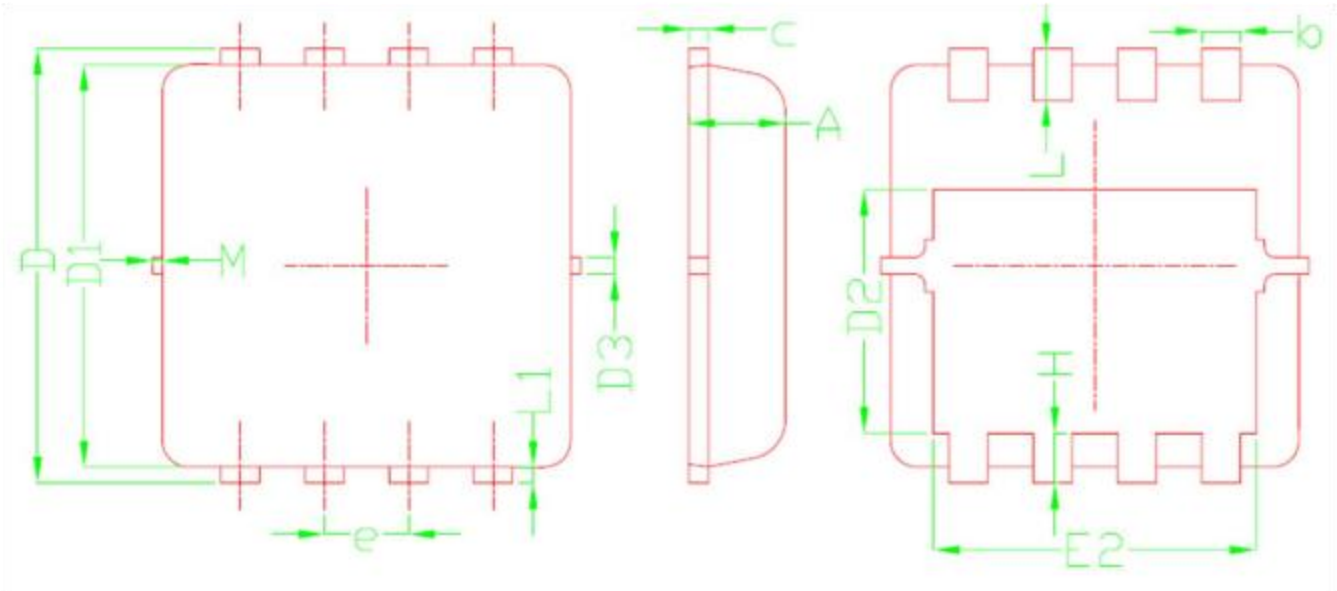
**Fig7 Power De-rating**



**Fig8 Source-Drain Diode Forward**

## Package Information

DFN3×3-8L



| SYMBOL          | DIMENSIONAL REQMTS |      |      |
|-----------------|--------------------|------|------|
|                 | MIN                | NOM  | MAX  |
| A               | 0.70               | 0.75 | 0.80 |
| b               | 0.25               | 0.30 | 0.35 |
| c               | 0.10               | 0.15 | 0.25 |
| D               | 3.25               | 3.35 | 3.45 |
| D1              | 3.00               | 3.10 | 3.20 |
| D2              | 1.78               | 1.88 | 1.98 |
| D3              | ---                | 0.13 | ---  |
| E               | 3.20               | 3.30 | 3.40 |
| E1              | 3.00               | 3.15 | 3.20 |
| E2              | 2.39               | 2.49 | 2.59 |
| e               | 0.65BSC            |      |      |
| H               | 0.30               | 0.39 | 0.50 |
| L               | 0.30               | 0.40 | 0.50 |
| L1              | ---                | 0.13 | ---  |
| θ               | ---                | 10°  | 12°  |
| M               | *                  | *    | 0.15 |
| * Not specified |                    |      |      |